Package

Pin Name

SMini2-F5-B

1: Cathode 2: Anode

Marking Symbol: A1

• Code

# DA2J101

### Silicon epitaxial planar type

#### For high speed switching circuits

#### Features

- Small reverse current I<sub>R</sub>
- Short reverse recovery time t<sub>rr</sub>
- Contributes to miniaturization of sets, reduction of component count.
- Eco-friendly Halogen-free package

#### Packaging

Embossed type (Thermo-compression sealing): 3000 pcs / reel (standard)

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Reverse voltage	V <sub>R</sub>	80	V	
Maximum peak reverse voltage	V <sub>RM</sub>	80	V	
Forward current	$I_{\rm F}$	100	mA	
Peak forward current	I <sub>FM</sub>	225	mA	
Non-repetitive peak forward surge current *	I <sub>FSM</sub>	500	mA	
Junction temperature	Tj	150	°C	
Storage temperature	T <sub>stg</sub>	-55 to +150	°C	

Note) \*: 1 t = 1 s

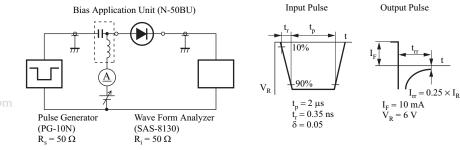
#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V <sub>F</sub>	$I_F = 100 \text{ mA}$		0.92	1.20	V
Reverse voltage	V <sub>R</sub>	$I_R = 100 \ \mu A$	80			V
Reverse current	I <sub>R</sub>	$V_R = 80 V$			100	nA
Terminal capacitance	Ct	$V_{R} = 0 V, f = 1 MHz$			1.2	pF
Reverse recovery time *	t <sub>rr</sub>	$I_F = 10 \text{ mA}, V_R = 6 \text{ V}, I_{rr} = 0.25 \times I_R$			3	ns

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. Absolute frequency of input and output is 100 MHz

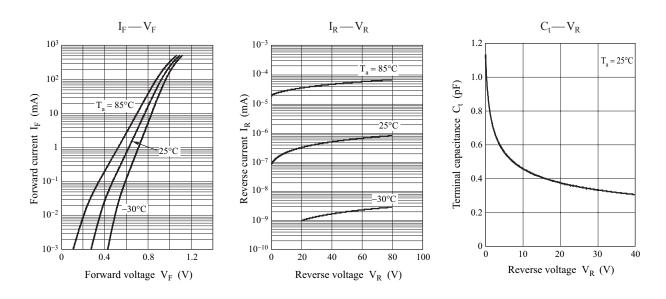
3. \*: t<sub>rr</sub> measurement circuit



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### DA2J101

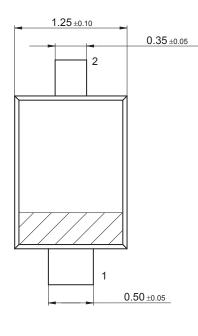
## **Panasonic**



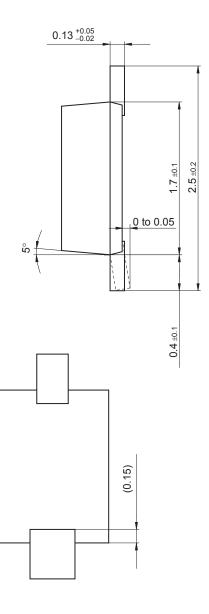
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### SMini2-F5-B

Unit: mm



0.7 ±0.1



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